



### AH1809

# LOW SENSITIVITY MICROPOWER OMNIPLOAR HALL-EFFECT SWITCH

# **Description**

The AH1809 is a low sensitivity micropower Omnipolar Hall Effect switch IC. It is designed for battery powered consumer products, home appliances, and industrial equipment such smart e-meters. Based on two Hall Effect plates and a chopper stabilized architecture the AH1809 provides a reliable solution over the whole operating range. To support battery and low power applications the design has been optimized to operate over the supply range of 2.5V to 5.5V and consumes only 24uW with a supply of 3V.

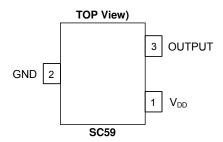
The single open drain output can be switched on with either a North or South pole of sufficient strength. When the magnetic flux density perpendicular to the package (B) is larger than operate point (Bop), the output is switched on (pulled low). The output is turned off when B becomes lower than the release point (Brp). The output will remain off when there is no magnetic field.

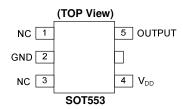
The AH1809 is available in SC59, SOT553 and SIP-3L.

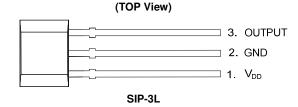
#### **Features**

- Omnipolar (North or South pole) Operation
- Low Sensitivity
- · Single Open Drain Output
- Micropower Operation
- 2.5V to 5.5V Operating Range
- Chopper Stabilized Design Provides
  - Superior Temperature Stability
  - Minimal Switch Point Drift
  - Enhanced Immunity to Stress
- Good RF Noise Immunity
- -40 °C to +125 °C Operating Temperature
- High ESD
- Small Low Profile SOT553 and Industry Standard SC59 and SIP-3L Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Pin Assignments**







# **Applications**

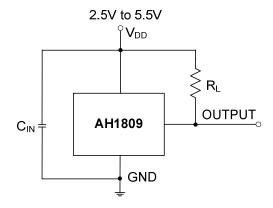
- Smart E-Meters
- Tamper Protection Switch
- Door, Lids and Tray Position Switch
- Proximity and Position Switches
- Level Detects
- On/Off Switch Digital Contact-Less Switch in Industrial and Consumer Products

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



# **Typical Applications Circuit**



Note:

4.  $C_{IN}$  is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF.  $R_L$  is the pull-up resistor, the recommended resistance is 10k $\Omega$  to 100k $\Omega$ .

# **Pin Descriptions**

Package: SC59 and SIP-3L

Pin Number	Pin Name	Function				
1	$V_{DD}$	Power Supply Input				
2	GND	Ground				
3	OUTPUT	Output Pin				

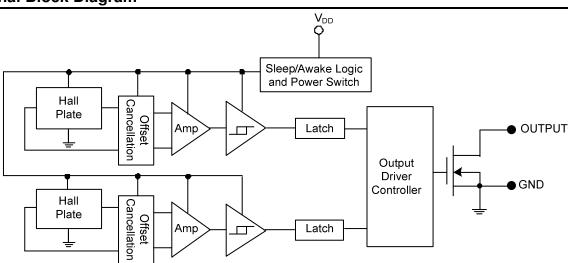
Package: SOT553

Pin Number	Pin Name	Function				
1	NC	No Connection (Note 5)				
2	GND	Ground				
3	NC	No Connection (Note 5)				
4	$V_{DD}$	Power Supply Input				
5	OUTPUT	Output				

Note:

5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

# **Functional Block Diagram**



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# Absolute Maximum Ratings (Note 6) (@T<sub>A</sub> = +25 ℃, unless otherwise specified.)

Symbol	Parameter		Rating	Unit
$V_{DD}$	Supply Voltage (Note 7)		7	V
V <sub>OUT</sub>	Output Pin Voltage (Note 7)		7	V
V <sub>DD REV</sub>	Reverse Supply Voltage		-0.3	V
V <sub>OUT_REV</sub>	Reverse Output Pin Voltage	-0.3	V	
Іоитрит	Output current (source and sink)	2.5	mA	
В	Magnetic Flux Density	Unlimited		
В	Package Power Dissipation	SC59 and SOT553	230	mW
$P_{D}$	Fackage Fower Dissipation	SIP-3L	230	_
Ts	Storage Temperature Range		-65 to +150	ç
$T_J$	Maximum Junction Temperature	+150	S	
ESD HBM	Human Body Model ESD capability		6	kV

Notes:

# **Recommended Operating Conditions** (@ $T_A = +25 \, ^{\circ}$ C, unless otherwise specified.)

Symbol	Parameter Conditions		Rating	Unit
$V_{DD}$	Supply Voltage	Operating	2.5 to 5.5	٧
$V_{OUT\_MAX}$	Maximum output pin voltage	Operating	5.5	٧
TA	Operating Temperature Range	Operating	-40 to +125	°C

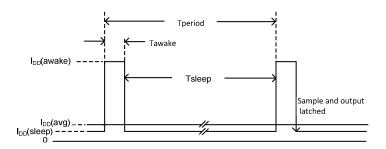
# Electrical Characteristics (@T<sub>A</sub> = +25°C, VDD = 3V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OUT_ON</sub>	Output On Voltage (V <sub>OL</sub> )	I <sub>OUT</sub> = 1mA	_	0.1	0.3	V
loff	Output Leakage Current	V <sub>OUT</sub> = 5.5V, Output off	_	< 0.1	1	μΑ
l (auralia)		During 'awake' period, T <sub>A</sub> = +25 °C, V <sub>DD</sub> = 3V		3	6	mA
I <sub>DD</sub> (awake)	- Supply Current	During 'awake' period, $T_A = -40 \text{ to } +125 ^{\circ}\text{C}, V_{DD} = 2.5 \text{V to } 5.5 \text{V}$	_	_	12	mA
I <sub>DD</sub> (sleep)	- Зарріу Сапені	During 'sleep' period, $T_A = +25 ^{\circ}\text{C}, V_{DD} = 3V$	_	5	10	μΑ
I <sub>DD</sub> (sleep)		During 'sleep' period, $T_A = -40 \text{ to } +125 ^{\circ}\text{C}, V_{DD} = 2.5 \text{V to } 5.5 \text{V}$	_	_	28	μΑ
J (0)(0)	Average Supply Current	T <sub>A</sub> = +25 °C, V <sub>DD</sub> = 3V	_	8	16	μΑ
I <sub>DD</sub> (avg)	Average Supply Current	$T_A = -40 \text{ to } +125 ^{\circ}\text{C}, V_{DD} = 2.5 \text{V to } 5.5 \text{V}$	_	_	40	μΑ
Tawake	Awake Time	(Note 8)	_	75	125	μs
Tperiod	Period	(Note 8)	_	75	125	ms
D.C.	Duty Cycle	-	_	0.1	_	%

Note: 8. When power is initially turned on, the operating V<sub>DD</sub> must be within its correct operating range (2.5V to 5.5V) to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 150ms).

Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
The absolute maximum V<sub>DD</sub> of 7V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.



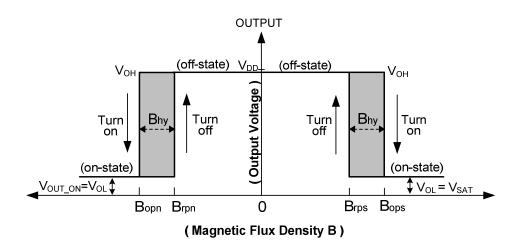


# Magnetic Characteristics (Notes 9 & 10) (T<sub>A</sub> = +25 °C, V<sub>DD</sub> = 2.5 V to 5.5 V, unless otherwise specified.)

					(1mT=10 (	Gauss)
Symbol	Characteristics	Test Condition	Min	Тур	Max	Unit
Dana (aguth nala ta nast masking aida)		T <sub>A</sub> = +25 °C	100	130	165	
Bops (south pole to part marking side)	Operation Reint	T <sub>A</sub> = -40 °C to +125 °C	90	130	185	
Dana (north pole to port morting side)	Operation Point	T <sub>A</sub> = +25 °C	-165	-130	-100	
Bopn (north pole to part marking side)		T <sub>A</sub> = -40 °C to +125 °C	-185	-130	-90	
Dyna (aguth nala ta nayt mayking aida)		T <sub>A</sub> = +25 ℃	90	115	150	Causa
Brps (south pole to part marking side)	Deleges Delet	T <sub>A</sub> = -40 °C to +125 °C	80	115	170	Gauss
Duran (north rollo to rout modified side)	Release Point	T <sub>A</sub> = +25 °C	-150	-115	-90	
Brpn (north pole to part marking side)		T <sub>A</sub> = -40 °C to +125 °C	-170	-115	-80	
Dhy (IDany) IDray)	Liveteresia (Nieto 11)	T <sub>A</sub> = +25 °C	10	15	20	
Bhy ( Bopx - Brpx )	Hysteresis (Note 11)	T <sub>A</sub> = -40 °C to +125 °C	5	15	_	

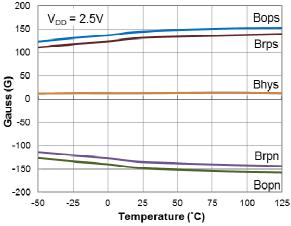
Notes:

- 9. Typical data is at  $T_A = +25\,^{\circ}\text{C}$ ,  $V_{DD} = 3V$ .
- 10. Parameters values over operating temperature range are not tested in production, they are guaranteed by design, process control and characterization. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.11. Maximum and minimum hysteresis is guaranteed by design and characterization.

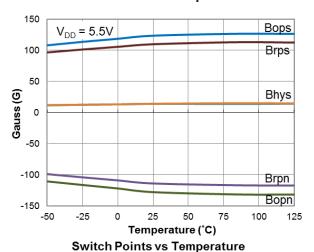


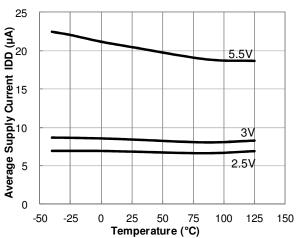


# **Typical Operating Characteristics**

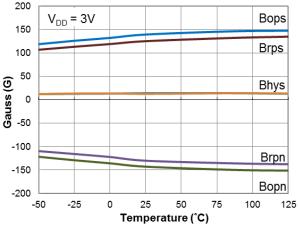


### **Switch Points vs Temperature**

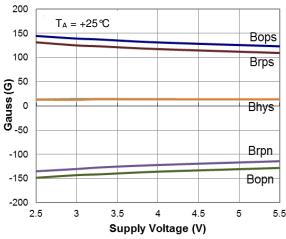




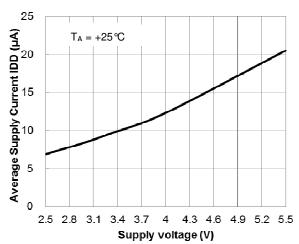
Average Supply Current vs. Temperature



Switch Points vs Temperature



**Switch Points vs Supply Voltage** 



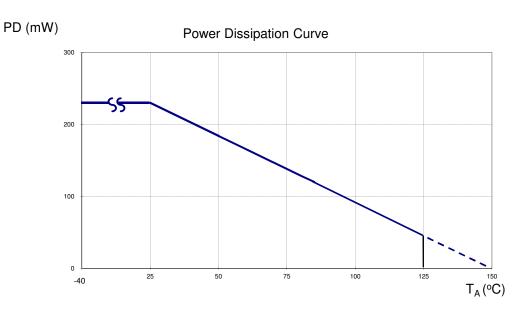
Average Supply Current vs. Supply Voltage



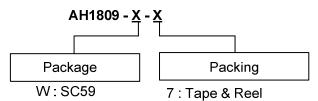
# **Thermal Performance Characteristics**

### (1) Package type: SC59, SOT553 and SIP-3L

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P <sub>D</sub> (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0



# **Ordering Information**



Z : SOT553 A : Ammo Box (Note 12) P : SIP-3L B : Bulk (Note 13)

			Bulk		7" Tape and Reel		Ammo Box	
Part Number	Package Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH1809-W-7	Z	SC59	NA	NA	3,000/Tape & Reel	-7	NA	NA
AH1809-Z-7	Z	SOT553	NA	NA	3,000/Tape & Reel	-7	NA	NA
AH1809-P-B	Р	SIP-3L	1000	-B	NA	NA	NA	NA
AH1809-P-A	Р	SIP-3L	NA	NA	NA	NA	4.000/Box	-A

Notes: 12. Ammo Box is for SIP-3L Spread Lead.

13. Bulk is for SIP-3L Straight Lead.



# **Marking Information**

### (1) Package Type: SC59

# (Top View)



XX: Identification code

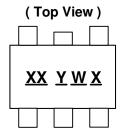
Y: Year 0 to 9

W: Week: A to Z: 1 to 26 week; a to z: 27 to 52 week; z represents 52 and 53 week

X: Internal Code

Part Number	Package	Identification Code	
AH1809	SC59	F9	

### (2) Package Type: SOT553



XX: Identification Code

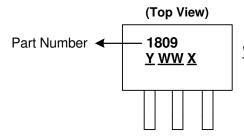
Y : Year : 0 to 9

W: Week: A to Z: 1~26 week; a to z: 27~52 week; z represents 52 and 53 week

X: Internal code

Part Number	Package	Identification Code		
AH1809	SOT553	H9		

### (3) Package Type: SIP-3L



Y: Year: 0~9

WW: Week: 01~52, "52" represents

52 and 53 week

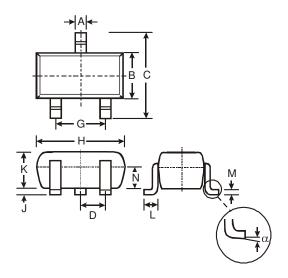
X: Internal Code



# Package Outline Dimensions (All dimensions in mm.)

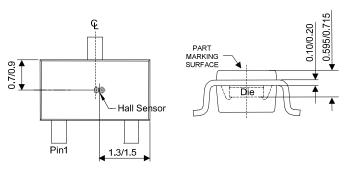
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### (1) Package Type: SC59



	SC59							
Dim	Min	Max	Тур					
Α	0.35	0.50	0.38					
В	1.50	1.70	1.60					
С	2.70	3.00	2.80					
D	-	-	0.95					
G	1	1	1.90					
Н	2.90	3.10	3.00					
J	0.013	0.10	0.05					
K	1.00	1.30	1.10					
L	0.35	0.55	0.40					
М	0.10	0.20	0.15					
N	0.70	0.80	0.75					
α	0°	8°	-					
All	Dimens	ions in	mm					





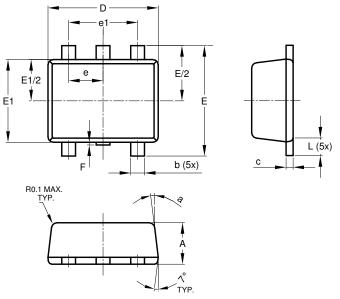
**Sensor Location** 



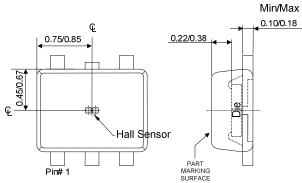
# Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

# (2) Package Type: SOT553



	SOT553							
Dim	Min	Max	Тур					
Α	0.55	0.62	0.60					
b	0.15	0.30	0.20					
C	0.10	0.18	0.15					
D	1.50	1.70	1.60					
Е	1.55	1.70	1.60					
E1	1.10	1.25	1.20					
е	(	).50 BS(	$\sim$					
e1	1	1.00 BS0	$\sim$					
F	0.00	0.10						
L	0.10	0.30	0.20					
а	6°	8°	7°					
All [	Dimensi	ions in ı	mm					



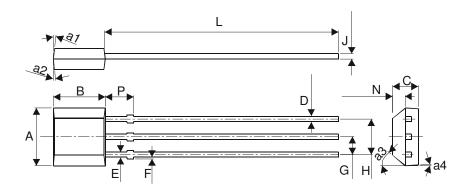
**Sensor Location** 



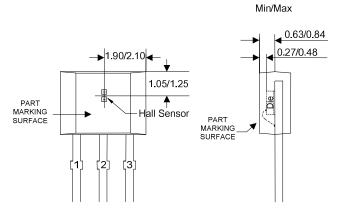
# Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### (3) Package Type: SIP-3L for Bulk Pack



SIP-3 for Bulk Pack			
Dim	Min	Max	
Α	3.9	4.3	
a1	5° Typ		
a2	5° Typ		
a3	45° Typ		
a4	3° Typ		
В	2.8	3.2	
С	1.40	1.60	
D	0.33	0.432	
Е	0.40	0.508	
F	0	0.2	
G	1.24	1.30	
Н	2.51	2.57	
7	0.35	0.43	
L	14.0	15.0	
N	0.63	0.84	
P	1.55	-	
All Dimensions in mm			



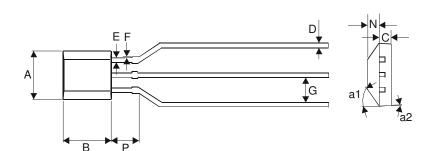
**Sensor location** 



# Package Outline Dimensions (cont.) (All dimensions in mm.)

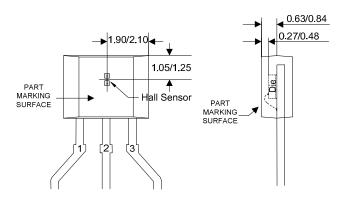
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### (4) Package Type: SIP-3L for Ammo Pack



SIP-3				
for Ammo Pack only				
Dim	Min	Max		
Α	3.9	4.3		
a1	45° Typ			
a2	3°Typ			
В	2.8	3.2		
С	1.40	1.60		
D	0.35	0.41		
E	0.43	0.48		
F	0	0.2		
G	2.4	2.9		
N	0.63	0.84		
Р	1.55	-		
All Dimensions in mm				

Min/Max



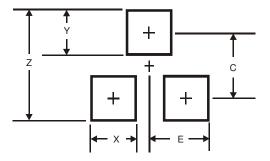
Sensor location



# **Suggested Pad Layout**

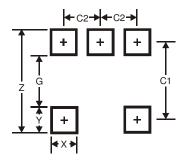
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### (1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Υ	1
С	2.4
E	1.35

# (2) Package Type: SOT553



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5



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